

N-Channel Enhancement Mode MOSFET

- Features

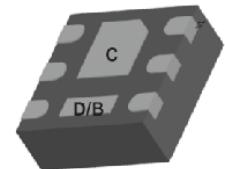
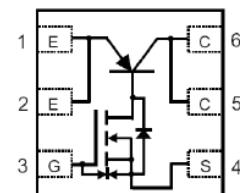
PNP Transistor

VCE	VBE	Vcesat max	Ic
-40v	-6v	-200mv	-3.0A

- Applications

- Li Battery Charging

- Pin configuration



Pin configuration(Top view)

General Description

SSC8P22CN2 combines an N-Channel enhancement mode MOSFET and a Media Power PNP Transistor. The tiny and thin outline saves PCB consumption.

- Package Information

Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	0.700		0.800
A1	0.000		0.050
A3		0.203 Ref.	
D	1.924	2.000	2.076
E	1.924	2.000	2.076
D1	0.850	0.950	1.050
E1	0.700	0.800	0.900
D2	0.200	0.300	0.400
E2	0.700	0.800	0.900
e1		0.650 Typ.	
e2		0.325 Typ.	
k		0.200 Min.	
b	0.250	0.300	0.350
e		0.650 Typ.	
L	0.300	0.350	0.400

- Absolute Maximum Ratings @ TA = 25°C unless otherwise specified**

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±12	
Drain Current ^(Note 1)	Continuous	I _D	A
	Pulsed	I _{DM}	
Collector-Emitter Voltage	V _{CEO}	-30	V
Emitter-Base Voltage	V _{EBO}	-6	V
Collector Current ^(Note 1)	Continuous	I _C	A
	Pulsed	I _{CM}	
Power Dissipation Derating above T _A = 25°C ^(Note 1)	P _d	1350	mW
Junction and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Note1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inches. The rating is for each chip in the package.

- Electrical Characteristics @ TA = 25°C unless otherwise specified**

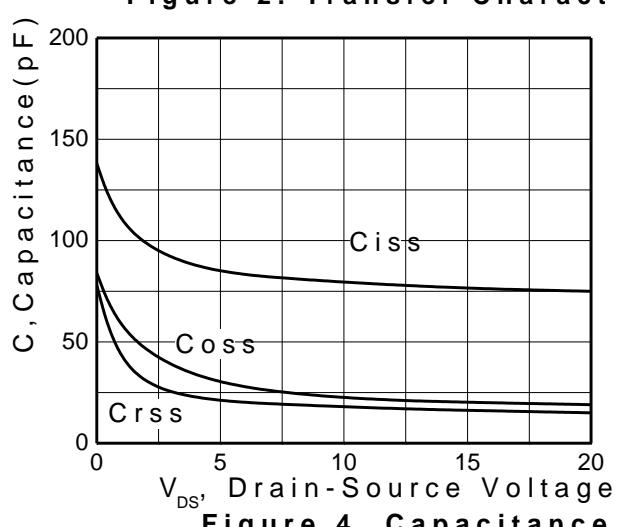
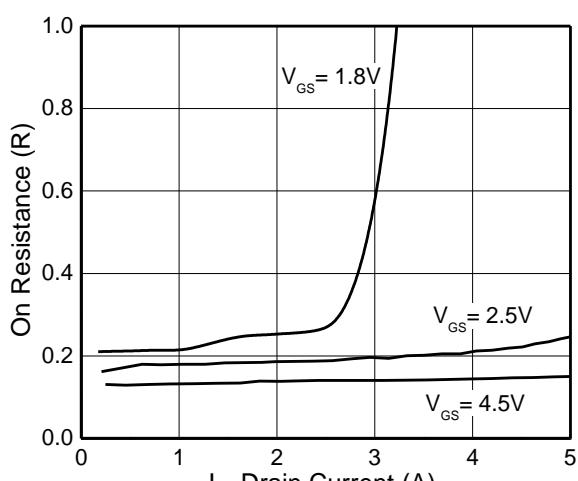
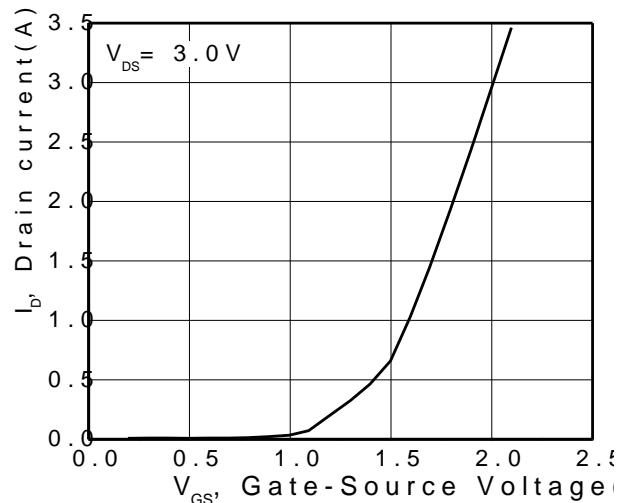
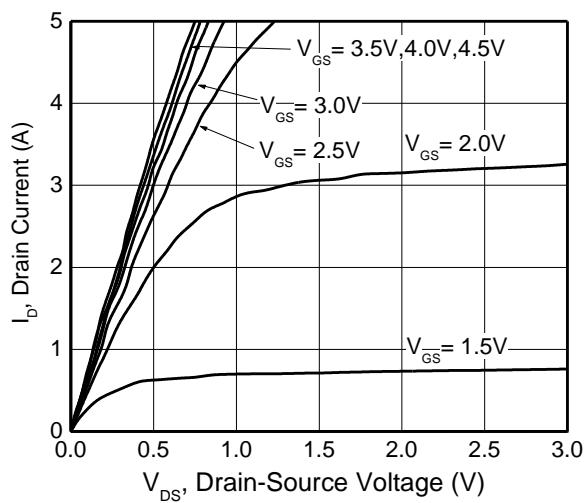
Parameter ^(Note 2)	Symbol	Test Conditions	Min	Typ	Max	Unit
N-Channel mosfet						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250µA	20	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 16V, V _{GS} = 0V	--	--	1	uA
Gate-Body Leakage	I _{GSS}	V _{GS} = ±12V, V _{DS} = 0V	--	--	±10	uA
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} = V _{GS} , I _D = 250uA	0.35	0.6	1	V
Static Drain-Source On-Resistance	R _{DS(ON)}	I _D =0.5A, V _{GS} = 4.5V	--	255	450	mR
		I _D = 0.5A, V _{GS} = 2.5V	--	390	765	
		I _D = 0.35A, V _{GS} = 1.8V	--	520	850	
Turn-On Delay Time	t _{d(on)}	V _{DD} = -6V, R _L = 6R, I _D = -1A, V _{GEN} = -4.5V, R _G = 6R	--	6	--	Ns
Turn-Off Delay Time	t _{d(off)}		--	28	--	
Input Capacitance	C _{iss}	V _{DS} = -16V, V _{GS} = 0V, f = 200KHz	--	130	--	pF
Output Capacitance	C _{oss}		--	20	--	
Reverse Transfer Capacitance	C _{rss}		--	16	--	
Diode Forward Voltage ⁽¹⁾	V _{SD}	V _{GS} = 0 V, I _S = 150mA	--	0.68	1.2	V
PNP Transistor						
Collector-Base Breakdown Voltage	BV _{CBO}	I _C =-50µA, I _B =0mA	-40			V
Collector-Emitter Breakdown Voltage	BV _{CEO}	I _C =-1mA, I _E =0mA	-40			V
Emitter-Base Breakdown Voltage	BV _{EBO}	I _E =-50µA, I _C =0mA	-6			V
Collector cut off current	I _{CBO}	V _{CB} =-30V, I _E =0mA			100	nA
Emitter cut off current	I _{EBO}	V _{EB} =-5V, I _C =0mA			100	nA
DC Current Gain	HFE	V _{C-E} =-2V, I _C =-500mA	100		350	
Collector-Emitter Saturation Voltage	V _{CESAT}	I _C =-1.5A, I _B =-80mA		0.15	-0.2	V

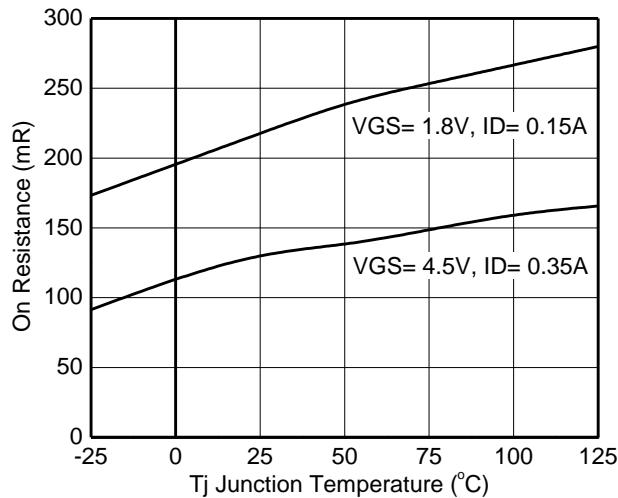
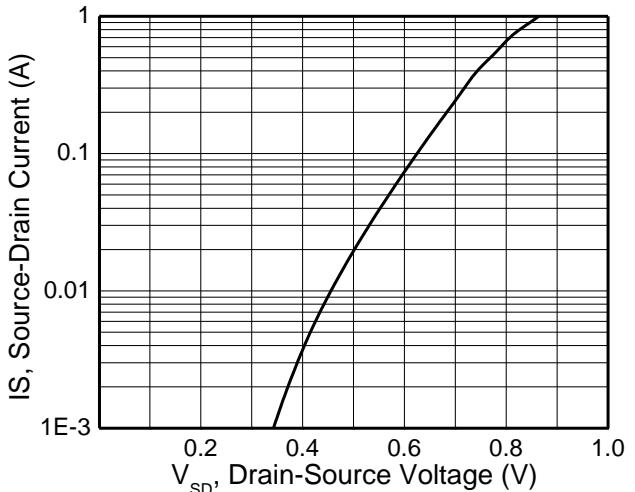
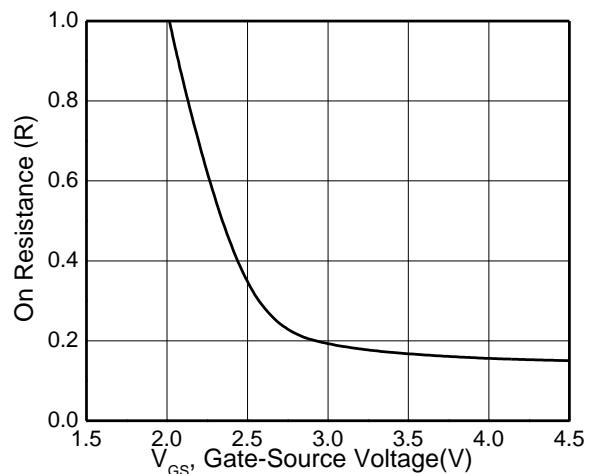
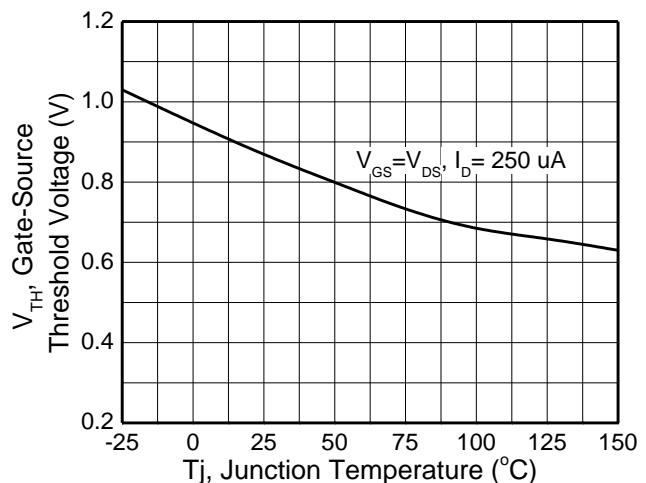
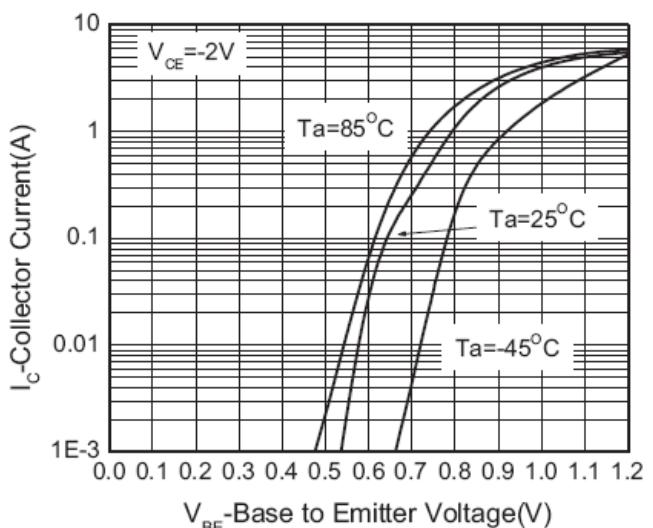
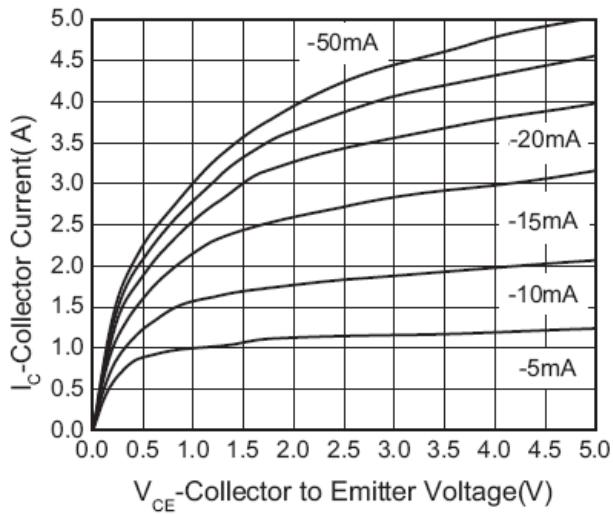
Note 2. Short duration test pulse used to minimize self-heating effect.

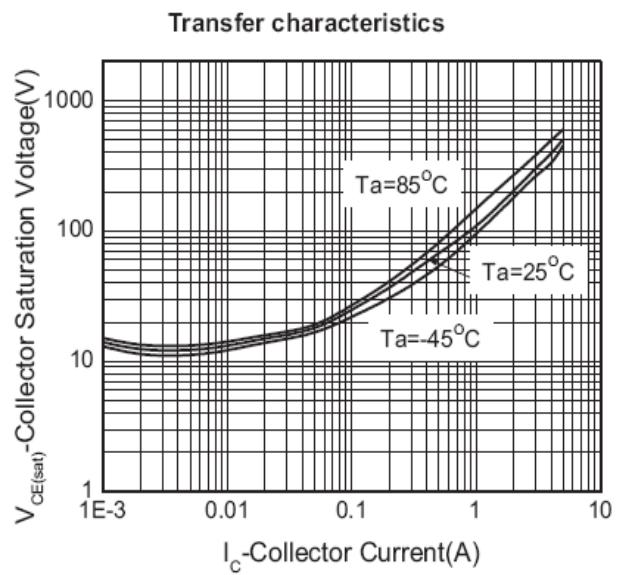
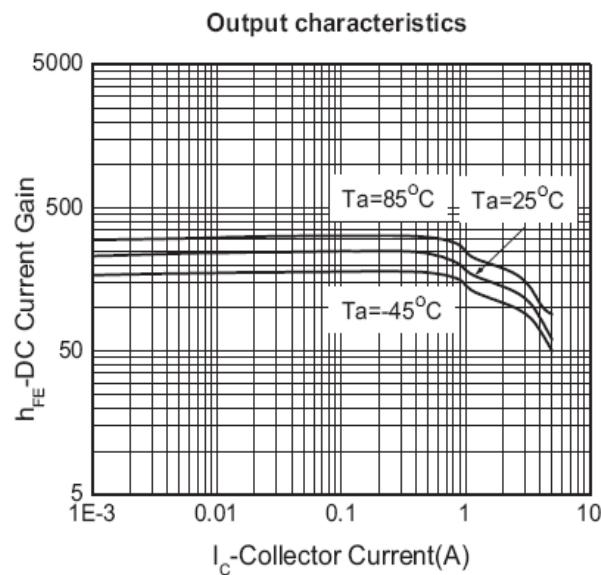
- Thermal resistance ratings

Parameter	Symbol	Value	Unit
Junction-to-Ambient Thermal Resistance ^a	R _{θJA}	105	°C/W
Junction-to-Ambient Thermal Resistance ^b	R _{θJA}	155	°C/W

- Typical Performance Characteristics



**Figure 5 . On resistance vs. Temperature****Figure 6. Diode Forward Characteristics****Figure 7. On Resistanc vs. Gate-Source Voltage****Figure 8. Gate Threshold vs. Temperature****PNP Transistor**





SSC8P22CN2

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